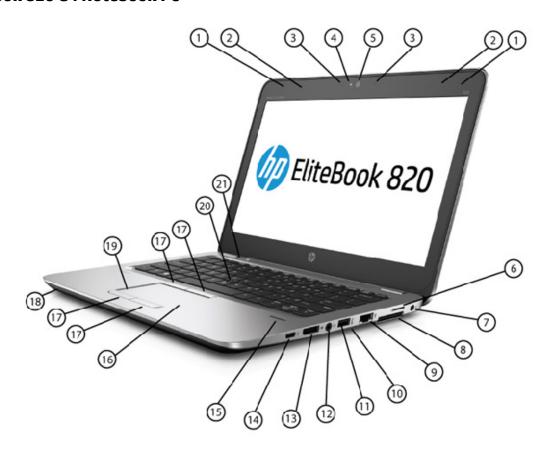
HP EliteBook 820 G4 Notebook PC

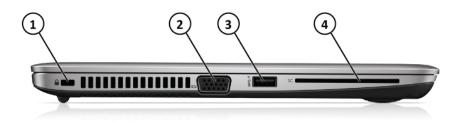


Front / Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. SIM card slot
- 7. Power connector
- 8. Docking connector

- 13. DisplayPort[™] 1.2
- 14. USB-C[™] port
- 15. Fingerprint reader (select models)
- 16. NFC (select models)
- 17. Touchpad buttons (4)
- 18. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 19. Touchpad
- 20. Pointstick





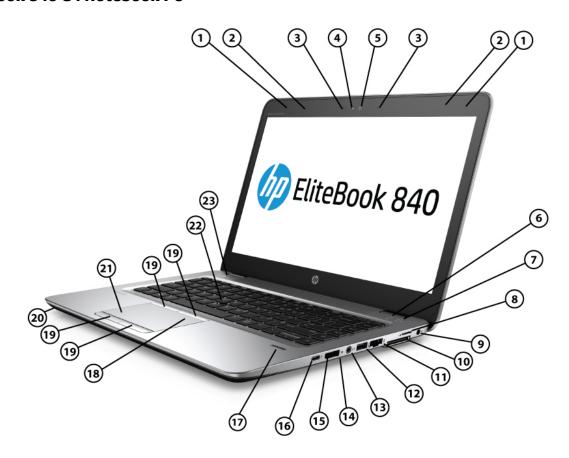
Left

- 1. Security lock slot
- 2. VGA port

- 3. USB 3.1 Gen 1 Charging port
- 4. Smart Card Reader



HP EliteBook 840 G4 Notebook PC

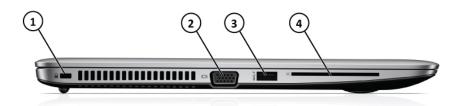


Front / Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2)
- 3. Internal microphones (2)
- Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. SIM card slot
- 9. Power connector
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.1 Gen 1 port

- 13. Microphone/ headphones combo jack
- 14. SD card slot
- 15. DisplayPort™ 1.2
- 16. USB-C[™] port
- 17. Fingerprint reader (select models)
- 18. NFC (select models)
- 19. Touchpad buttons (4)
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. Touchpad
- 22. Pointstick
- 23. Power button





Left

- 1. Security lock slot
- 2. VGA port

- 3. USB 3.1 Gen 1 Charging port
- 4. Smart Card Reader



HP EliteBook 850 G4 Notebook PC



Front / Right

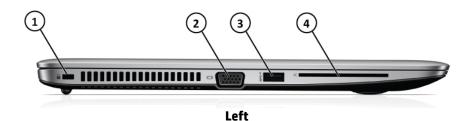
- 1. WLAN antennas (2)
- 2. WWAN antennas (2)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. SIM card slot
- 9. Power connector
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.1 Gen 1 port

- 13. SD card slot
- 14. Microphone/ headphones combo jack
- 15. DisplayPort™ 1.2
- 16. USB-C[™] port
- 17. Fingerprint reader (select models)
- 18. NFC (select models)
- 19. Touchpad buttons (4)
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. Touchpad
- 22. Pointstick
- 23. Power button



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Overview



- 1. Security lock slot
- 2. VGA port

- 3. USB 3.1 Gen 1 Charging port
- 4. Smart Card Reader



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Overview

AT A GLANCE

- Stylish magnesium and aluminum chassis provides optimal durability with minimal weight
- Thin design but no adapters are needed with built-in VGA, drop-jaw RJ-45 Ethernet port, USB 3.1 Gen 1 Ports, USB Type-C™, and full-size DisplayPort™ 1.2 for high resolution support
- Design allows memory, storage, wireless modules, and battery to be customer serviceable and upgradeable
- Choice of 7th generation Intel® Core™ i7, i5 and i3 processors
- Integrated Intel® HD Graphics 620 or AMD Radeon™ R7 M465 discrete graphics (HP EliteBook 850 option only)
- Optimize your audio experience for conference calls and remote collaboration with optional HD webcam, dual-array microphones, premium speakers, HP Noise Cancellation Software, HP Audio Boost, and audio custom-tuned by HP and Bang & Olufsen
- Featuring HP Premium Keyboard with Pointstick and 10-key numeric keypad available on HP EliteBook 850
- Optional back-lit keyboard keeps you productive in all settings with HP DuraKeys to help protect keys from fading
- Passed MIL-SPEC 810G testing, plus an additional 120,000 hours of reliability testing through HP's Total Test Process¹
- Enhanced security features including TPM2.0, SmartCard Reader, HP Sure Start self-healing BIOS, HP Client Security, Self-Encrypting storage drives, and optional Fingerprint reader
- HP Touchpoint Manager³, HP Image Assistant and HP Management Integration Kit provide additional tools for more
 efficient manageability
- LED-backlit displays:
 - o HP EliteBook 820: 31.75 cm (12.5") diagonal HD, FHD Non-Touch or FHD Touch
 - o HP EliteBook 840: 35.56 cm (14") diagonal HD, FHD, QHD Non-Touch or FHD Touch
 - o HP EliteBook 850: 39.6 cm (15.6") diagonal HD, FHD, UHD Non-Touch or FHD Touch
- Flexible wireless connectivity options including 4G LTE mobile broadband
- Easily dock with the optional HP UltraSlim Docking Station
- Choice of hard drives up to 1 TB and solid state drives up to 512 GB
- DDR4 memory up to 32 GB
- Preinstall Windows 10, FreeDOS 2.0 or NeoKylin Linux 64 versions
 - 1. MIL STD 810G testing is not intended to demonstrate fitness for Department of Defense contracts requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.
 - 2. Recharges your battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
 - 3. HP Touchpoint Manager requires purchase of a subscription and supports Android™, iOS and Windows 7 or higher operating systems and PCs, notebooks, tablets and smartphones from various manufacturers. Not available in all countries see www.hp.com/touchpoint for availability information.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

PRODUCT NAMES

HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64¹

Windows 10 Home 641

FreeDOS 2.0 NeoKylin Linux 64

Web Supported Windows 10 Enterprise 64¹

Note: Your product does not support Windows 8 or Windows 7

In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

PROCESSOR

Intel® Core™ i7-7600U (2.8 GHz, up to 3.9 GHz with Intel Turbo Boost Technology, 4 MB cache, 2 cores)¹ Intel® Core™ i7-7500U (2.7 GHz, up to 3.5 GHz with Intel Turbo Boost Technology, 4 MB cache, 2 cores)¹.2 Intel® Core™ i5-7300U (2.6 GHz, up to 3.5 GHz with Intel Turbo Boost Technology, 3 MB cache, 2 cores)¹ Intel® Core™ i5-7200U (2.5 GHz, up to 3.1 GHz with Intel Turbo Boost Technology, 3 MB cache, 2 cores)¹.2 Intel® Core™ i3-7100U (2.4 GHz, 3 MB cache, 2 cores)¹.2

- 1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- 2. Not available with Intel iAMT (Not available with vPro™)

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

CHIPSET

Chipset integrated with processor



INTEL® CORE 15 WITH vPro/Core 17 WITH vPro TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro™ and Intel® Core® i7 with vPro™ technology is a selectable feature that is available on units configured with select processors, on select Intel® Wireless WLAN module and a preinstalled Windows operating system.

1. Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of this technology, such as Intel® Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro technology is dependent on 3rd party software providers. Microsoft Windows required.

GRAPHICS

Integrated

Intel® HD Graphics 620

Discrete

AMD Radeon™ R7 M465 2 GB GDDR5 dedicated (HP EliteBook 850 only)

DISPLAY

HP EliteBook 820

Internal

Non-Touch

31.75 cm (12.5") diagonal HD SVA anti-glare slim LED-backlit non-touch (1366 x 768)

31.75 cm (12.5") diagonal HD SVA anti-glare slim LED-backlit non-touch with camera (1366 x 768)

31.75 cm (12.5") diagonal FHD UWVA anti-glare ultra-slim LED-backlit non-touch (1920 x 1080)

31.75 cm (12.5") diagonal FHD UWVA anti-glare ultra-slim LED-backlit non-touch with camera (1920 x 1080)

Touch

31.75 cm (12.5") diagonal FHD UWVA ultra slim with camera, Corning® Gorilla® Glass 4 LED-backlit touch screen (1920 x 1080)

HP EliteBook 840

Internal

Non-Touch

35.56 cm (14") diagonal HD SVA anti-glare slim LED-backlit non-touch (1366 x 768)

35.56 cm (14") diagonal HD SVA anti-glare slim LED-backlit non-touch with camera (1366 x 768)

35.56 cm (14") diagonal FHD SVA anti-glare slim LED-backlit non-touch (1920 x 1080)

35.56 cm (14") diagonal FHD SVA anti-glare slim LED-backlit non-touch with camera (1920 x 1080)

35.56 cm (14") diagonal QHD UWVA anti-glare ultraSlim LED-backlit non-touch (2560 x 1440)

35.56 cm (14") diagonal QHD UWVA anti-glare ultraSlim LED-backlit non-touch with camera (2560 x 1440)

HP Sure View integrated privacy screen 35.56 cm (14") diagonal FHD SVA anti-glare slim LED-backlit non-touch with camera (1920 x 1080) (Planned to be available first quarter 2017 and must be configured at purchase.)

Touch

35.56 cm (14") diagonal FHD SVA slim with camera, Corning® Gorilla® Glass 4 LED-backlit touch screen (1920 x 1080)



HP EliteBook 850

Internal

Non-Touch

39.6 cm (15.6") diagonal HD SVA anti-glare slim LED-backlit non-touch (1366 x 768)

39.6 cm (15.6") diagonal HD SVA anti-glare slim LED-backlit non-touch with camera (1366 x 768)

39.6 cm (15.6") diagonal FHD SVA anti-glare slim LED-backlit non-touch (1920 x 1080)

39.6 cm (15.6") diagonal FHD SVA anti-glare slim LED-backlit non-touch with camera (1920 x 1080)

39.6 cm (15.6") diagonal UHD UWVA anti-glare slim LED-backlit non-touch (3840 x 2160)

39.6 cm (15.6") diagonal UHD UWVA anti-glare slim LED-backlit non-touch with camera (3840x 2160)

Touch

39.6 cm (15.6") diagonal FHD SVA slim with camera, Corning® Gorilla® Glass 4 LED-backlit touch screen (1920 x 1080)

VGA

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

DisplayPort™ 1.2

Supports resolutions up to 4096 x 2304 @ 60Hz

Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Displays support

Supports dual display through the dock

Supports 3 independent displays if used with optional HP UltraSlim Docking Station.²

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

- 1. HD content required to view HD images.
- 2. Sold separately or as an optional feature.

STORAGE AND DRIVES

SATA, 7 mm 2.5" Hard Drives

500 GB 7200 rpm Hard Drive

500 GB 7200 rpm Self-Encrypting Hard Drive (Opal 2)

500 GB 7200 rpm Self-Encrypting Hard Drive FIPS-140-2

500 GB Hybrid 8 GB Cache

1 TB 5400 rpm Hard Drive

M.2 (NGFF) 2280 Solid State Drives

128 GB SATA-3 Value Solid State Drive

256 GB PCIe Gen3x4 NVMe TLC Solid State Drive

360 GB PCIe Gen3x4 NVMe TLC Solid State Drive (Planned to be available first quarter 2017.)

512 GB PCIe Gen3x4 NVMe TLC Solid State Drive

512 GB PCIe Gen3x4 NVMe MLC Solid State Drive

256 GB SATA-3 TLC Self-Encrypting Solid State Drive (Opal 2)

512 GB PCIe Gen 3x4 NVMe TLC Self-Encrypting Solid State Drive (Opal 2)

512 GB SATA-3 TLC Solid State Drive FIPS-140-2 (Planned to be available first quarter 2017.)



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

HP 3D DriveGuard (Windows and Hard Drives only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive

Dual Drive Configuration

HP EliteBook 840 & 850 can be configured with a hard drive and M.2 SSD drive.

MEMORY

Supports the following configurations

DDR4 – 2400 SDRAM (Transfer rates up to 2133 MT/s) Two SODIMM slots supporting dual-channel memory Both slots are customer accessible / upgradeable

Standard

4096 MB Total System Memory (4096 MB x 1) 8192 MB Total System Memory (4096 MB x 2) 8192 MB Total System Memory (8192 MB x 1) 16384 MB Total System Memory (8192 MB x 1) 16384 MB Total System Memory (8192 MB x 2) 32768 MB Total System Memory (16384 MB x 2)

Maximum Memory

Up to 32 GB

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

NOTE: Improved system performance when memory is added in pairs (dual channel).

Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Optional Broadband Wireless (WWAN) requires a Windows operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth® is also available with any of the supported wireless LAN and wireless WAN options.

Broadband Wireless (WWAN) Via M.2 Minicard

HP lt4120 Qualcomm[®] Snapdragon[™] X5 LTE Mobile Broadband Module ¹ HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module ¹ HP hs3210 WW HSPA+ with GPS Mobile Broadband ¹

Note: The HP EliteBook 850 G4 UHD panel is not compatible with WWAN.



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

Wireless LAN (WLAN) Via M.2 Minicard

Intel® Dual Band Wireless-AC 8265 802.11 a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 combo (vPro and non-vPro)² Intel® Dual Band Wireless-AC 3168 802.11 a/b/g/n/ac (1x1) WiFi and Bluetooth® 4.2 combo (non-vPro)²

Near Field Communication (NFC)¹

HP Module with NXP NFC Controller NPC100 I2C NCI

Support for Miracast

- 1. Sold separately or as an optional feature.
- 2. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.
- 3. WWAN module requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Communications

Intel® Ethernet Connection I219-V 10/100/1000 Ethernet (With Intel® i3-7100U, i5-7200U, and i7-7500U) Intel® Ethernet Connection I219-LM 10/100/1000 Ethernet (With Intel® i5-7300U and i7-7600U)

NOTE: The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen HP Audio Boost HP Noise Cancellation Software Digital Microphones (Dual Array) 2 Premium Stereo Speakers

Webcam

Optional¹ 720p HD² webcam³

- 1. Sold separately or as an optional feature.
- 2. HD content required to view HD images.
- 3. Internet access required.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard

The HP Premium, spill-resistant keyboard with drain is designed using a thin layer of Mylar film under the keyboard and includes an all-metal keyboard deck for greater rigidity. Backlit keyboard with HP DuraKeys is available as an option.



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

The 820 has 79/80-key, 840 has 85-86-key, the 850 has 100/101-key compatible keyboard and features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys.

US and International key layouts are available.

Pointing Devices

Glass Touchpad On/Off button

Taps enabled as default

Gestures enabled by default - 2 Finger Scrolling, 2 Finger Zoom (Pinch)

Function Keys HP EliteBook 820

HA FIITGROOK 85

F1 - Sleep

F2 - Blank

F3 - Backlit Keyboard Toggle

F4 - Display Switching

F5 - Brightness Down

F6 - Brightness Up

F7 - Audio Mute

F8 - Volume Down

F9 - Volume Up

F10 - Mic Mute

F11 - Wireless

F12 - Num Lock

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rg

Fn+C - Scroll Lock

HP EliteBook 840

F1 - Sleep

F2 - Blank (Privacy Key for configurations with HP Sure View integrated privacy screen)

F3 - Backlit Keyboard Toggle

F4 - Display Switching

F5 - Brightness Down

F6 - Brightness Up

F7 - Blank

F8 - Volume Down

F9 - Volume Up

F10 - Mic Mute

F11 - Blank

F12 - Num Lock

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

HP EliteBook 850

F1 - Sleep

F2 - Blank

F3 - Backlit Keyboard Toggle

F4 - Display Switching

F5 - Brightness Down

F6 - Brightness Up

F7 - Blank

F8 - Volume Down

F9 - Volume Up

F10 - Mic Mute

F11 - Blank F12 - Blank

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

SOFTWARE AND SECURITY

Preinstalled Software BIOS

HP BIOSphere¹

HP Sure Start Gen3¹⁰

HP DriveLock | HP Automatic DriveLock

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Secure Erase²

Pre-boot Authentication

Communication/Connectivity

HP Mobile Connect Pro (Windows 10 only)3

Native Miracast Support⁴

HP LAN-WLAN Protection

HP MAC Address Manager

HP Wireless Wakeup

HP Value Add Software

HP 3D DriveGuard (requires Windows)

HP ePrint Driver +JetAdvantage5

HP Hotkey Support

HP Recovery Manager

HP Jumpstart



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

HP Support Assistant
HP Noise Cancellation Software

Microsoft Products

Buy Office Bing Search Skype⁶

Manageability

HP Driver Packs⁷
HP SoftPaq Download Manager (SDM)
HP System Software Manager (SSM)⁷
HP BIOS Config Utility (BCU)⁷
HP Client Catalog⁷
HP MIK for Microsoft SCCM⁷
HP Image Assistant⁷
LANDESK Management⁸

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.

Client Security Software

HP Client Security

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Fingerprint Sensor
- HP Password Manager
- Absolute Persistence Module⁹
- Power On Authentication
- HP Device Access Manager

Microsoft Defender

Security

Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified. Convertible to FIPS 140-2 Certified mode. (TPM 2.0 is not available for Win 7 32-bit.) Fingerprint Reader (On select models)

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

- 1. Available only on business PCs with HP BIOS. HP BIOSphere features may vary depending on the PC platform & configuration.
- 2. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

- 3. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to www.hp.com/go/mobileconnect
- 4. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 5. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
- 6. Skype is not offered in China.
- 7. Not preinstalled, however available for download in December 2015 at http://www.hp.com/go/clientmanagement
- 8. Subscription required.
- 9. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: https://www.absolute.com/en/about/legal/agreements/absolute. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 10. Available on HP EliteBook products equipped with Intel® 7th generation processors.

POWER

Power Supply¹

HP 45W Smart AC Adapter HP 45W 2-prong DC jack AC Adapter HP 65W Smart AC Adapter² HP 65W Smart AC Adapter EM²

- 1. Availability may vary by country.
- 2. Supports HP Fast Charging. Required for HP EliteBook 850 configured with optional discrete graphics.

Power cord is configurable; either 3.2 feet or 6 feet (1.0 or 1.8 meter)
Total length including external AC adapter is 9.2 feet or 12 feet (2.86 or 3.66 meter)

Battery

HP EliteBook 820

HP Long Life 3-cell, 49 WHr Li-ion polymer (Supports HP Fast Charging with 65W AC Adapter)

HP EliteBook 840 & 850

HP Long Life 3-cell, 51 WHr Li-ion polymer (Supports HP Fast Charging with 65W AC Adapter)



Technical Specifications

Battery Life¹

Platform	Other HW Details	Battery	UMA Graphics	Discrete Graphics
HP EliteBook 820 G4	HDD	3-cell (49WHr)	Up to 11 hrs 15 mins	N/A
HP EliteBook 820 G4	SSD	3-cell (49WHr)	Up to 14 hrs 45 mins	N/A
HP EliteBook 840 G4	HDD	3-cell (51WHr)	Up to 12 hrs 15 mins	N/A
HP EliteBook 840 G4	SSD	3-cell (51WHr)	Up to 15 hrs 15 mins	N/A
HP EliteBook 850 G4	HDD	3-cell (51WHr)	Up to 12 hrs 15 mins	Up to 11 hrs 30 mins
HP EliteBook 850 G4	SSD	3-cell (51WHr)	Up to 14 hrs 15 mins	Up to 14 hrs 15 mins

^{1.} Windows 10/MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

Power Conservation

Hibernation Standby ACPI compliance

WEIGHTS & DIMENSIONS

HP EliteBook 820

Weight1

Starting at 2.78 lbs (1.26 kg)

(3-cell battery (49WHr), UMA, no FPR, 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, Non-Touch panel) Starting at 3.05 lbs (1.38 kg)

(3-cell battery (49WHr), UMA, no FPR, 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, Touch)

Dimensions² (w x d x h) 12.2 x 8.6 x 0.74 in (Front) 31 x 21.89 x 1.89 cm

HP EliteBook 840 Weight¹



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

Starting at 3.27 lbs (1.48 kg)

(3-cell battery (51WHr), UMA, no FPR, 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, Non-Touch panel) Starting at 3.76 lbs (1.70 kg)

(3-cell battery (51WHr), UMA, no FPR, 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, Touch)

Dimensions² (w x d x h)

13.3 x 9.3 x 0.74 in (Front) 33.8 x 23.7 x 1.89 cm

HP EliteBook 850

Weight1

Starting at 4.06 lbs (1.84 kg)

(3-cell battery (51WHr), UMA, no FPR, 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, Non-Touch panel)

Starting at 4.54 lbs (2.06 kg)

(3-cell battery (51WHr), UMA, no FPR, 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, Touch)

Dimensions² (w x d x h)

15.10 x 10.10 x 0.76 in (Front)

38.36 x 25.77 x1.94 cm

- 1. Weight varies by configuration and components.
- 2. Height varies depending upon where on the notebook the measurement is made.

PORTS/SLOTS

Ports

1 USB 3.1 Gen 1 Charging Port

1 USB 3.1 Gen 1 Port

1 USB-C™ port (Up to 5 Gbps data transfer and 15W power)

1 DisplayPort™ 1.2

1 VGA

1 RJ-45 / Ethernet

1 Docking connector

1 Headphone/Microphone Combo

1 AC Port

NOTE: Cables are not included.

Slots

SD Media Card Reader Slot Supports SD, SDHC, SDXC



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional HP Care Pack Services are extended service contracts which go beyond your standard limited warranties.

 HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



SYSTEM UNIT

Stand-Alone Power	Nominal Operating Voltage	19.5 V	
Requirements (AC Power)	Average Operating Power	Windows 10 (64-bit)	
	Integrated graphics	12.9 W	
	Max Operating Power	Discrete < 90W UMA < 65W	
Temperature Operating		32° to 95° F (0° to 35° C) (not writing optical)	
		41° to 95° F (5° to 35° C) (writing optical)	
	Non-operating	-4° to 140° F (-20° to 60° C)	
Relative Humidity		10% to 90%, non-condensing	
		5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature	
Shock	Operating	40 G, 2 ms, half-sine	
	Non-operating	200 G, 2 ms, half-sine	
Random Vibration	Operating	0.75 grms	
	Non-operating	1.50 grms	
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
	Non-operating	-50 to 15,000 ft (-15.24 to 12,192 m)	
Planned Industry Standard	UL	Yes	
Certifications	CSA	Yes	
	FCC Compliance	Yes	
	ENERGY STAR®	Select models*	
	EPEAT®	Registered Gold in United States**	
	ICES	Yes	



Technical Specifications

Australia / NZ RCM Compliance	Yes
ссс	Yes
Japan VCCI Compliance	Yes
КС	Yes
BSMI	Yes
CE Marking Compliance	Yes
СІТ	Yes
EAC	Yes
Saudi Arabian Compliance (SASO)	Yes
SABS	Yes
UKRSERTCOMPUTER	Yes

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

Displays

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

31.75 cm (12.5") diagonal LED backlight HD Slim eDP SVA Antiglare non-touch (1366 x 768) **Outline Dimensions** 291.0 x 181.9 X 3.0 mm (max) (W x H x D)

Active Area 276.62 mm x 155.52 mm

Weight 250g max

Diagonal Size 31.75 cm (12.5")

Surface Treatment AG

Contrast Ratio 300:1 (typ)



Technical Specifications

Refresh Rate 60Hz Response time 16ms typ. Pixel Per Inch (PPI) 125 **Brightness** 220nits

Format 1366 x 768 (HD) **Pixel Resolution**

Configuration **RGB**

Interface eDP 1.2 **LCD Mode** TN

Viewing Angle SVA 45/45/25/35

31.75 cm (12.5") diagonal LED backlight **FHD UltraSlim eDP UWVA** Anti-glare non-touch (1920 x 1080)

31.75 cm (12.5")

diagonal LED backlight

(1920 x 1080) Touch

FHD UltraSlim eDP UWVA

Outline Dimensions

 $(W \times H \times D)$

282.7 x 179.82 x 2.3 (mm) max

Active Area 276.48 x 155.52 mm

Weight 170g max **Diagonal Size** 31.75 cm (12.5")

Surface Treatment AG

Contrast Ratio 600:1 (typ) **Refresh Rate** 60Hz Response time 25ms typ. Pixel Per Inch (PPI) 176 **Brightness** 300nits

Format 1920 x 1080 (FHD) **Pixel Resolution**

RGB Configuration

282.7 x 179.82 x 2.3 (mm) max

Interface eDP 1.3 + PSR **LCD Mode** IPS/FFS/VA

Viewing Angle UWVA 85/85/85/85

 $(W \times H \times D)$

Outline Dimensions

Active Area 276.48 x 155.52 mm

Weight 170g max

Diagonal Size 31.75 cm (12.5")

Touch Enabled Yes

TSP Type Capacitive

Surface Treatment Anti-smudge/fingerprint coating

Contrast Ratio 600:1 (typ) **Refresh Rate** 60Hz Response time 25ms typ. Pixel Per Inch (PPI) 176 **Brightness** 300nits



Format 1920 x 1080 (FHD) **Pixel Resolution**

Configuration **RGB** Interface eDP 1.3 + PSR

LCD Mode IPS/FFS/VA

Viewing Angle UWVA 85/85/85/85

35.56 cm (14") diagonal Outline **LED backlight FHD Slim** eDP SVA Anti-glare (1920 x 1080) Non-Touch

Integrated Privacy Screen

Dimensions 320.9 x 205.6 (max) x 3.6 (max) mm

Active Area 309.14 x 173.89 mm

Weight <305 g max

 $(W \times H \times D)$

Diagonal Size 35.56 cm (14") **Surface Treatment** Anti-Glare (AG) **Contrast Ratio** 200:1 (typ) - AG

Refresh Rate 60Hz Response time 16ms typ. Pixel Per Inch (PPI) 157

Brightness Privacy 85nits typ. (system)

Sharing 275nits typ. (system)

Format 1920 x 1080 (FHD) **Pixel Resolution**

Configuration **RGB Stripe**

Interface eDP 1.2 (2 lane)

LCD Mode TN

 $(W \times H \times D)$

Viewing Angle Sharing 45/45/15/30 (CR>10)

Privacy 40/40/15/30 (CR>10)

35.56 cm (14") diagonal Outline Dimensions **LED backlight HD Slim** eDP SVA Anti-glare nontouch (1366 x 768)

320.9 x 205.6 (max) x 3.0mm max

Active Area 309.4 x 173.95 (mm)

Weight 290 g max **Diagonal Size** 35.56 cm (14") **Surface Treatment** Anti-Glare (AG) **Contrast Ratio** 300:1 (typ) **Refresh Rate** 60Hz **Response time** 16ms typ. Pixel Per Inch (PPI) 112 **Brightness** 220nits



Format 1366 x 768 (HD) **Pixel Resolution** Configuration **RGB**

Interface eDP 1.2 **LCD Mode** TN

Viewing Angle SVA 45/45/25/35

35.56 cm (14") diagonal Outline Dimensions **LED backlight FHD Slim** eDP SVA Anti-glare non-

touch (1920 x 1080)

 $(W \times H \times D)$

320.9 x 205.6 (max) x 3.0(max) mm

Active Area 309.40 x 173.95 (mm)

Weight 270 g max

Diagonal Size 14"

Surface Treatment Anti-Glare (AG) **Contrast Ratio** 300:1 (typ) **Refresh Rate** 60Hz Response time 16ms typ. Pixel Per Inch (PPI) 157 **Brightness** 300nits

Format 1920 x 1080 (FHD) **Pixel Resolution**

309.50 x 174.10 (mm)

270g max

Configuration **RGB**

320.9 x 205.6 (mm) max x 2.6 (mm) max

Interface eDP 1.2 **LCD Mode** TN

Viewing Angle SVA 45/45/25/35

35.56 cm (14") diagonal Outline Dimensions **LED backlight QHD**

UltraSlim eDP UWVA Anti- Active Area

glare non-touch (2560 x 1440)

 $(W \times H \times D)$

Weight

Diagonal Size 35.56 cm (14") **Surface Treatment** Anti-Glare (AG) **Contrast Ratio** 600:1 (typ.)

Refresh Rate 60Hz Response time 30 ms typ. Pixel Per Inch (PPI) 210

Brightness 340 nits **Format**

Pixel Resolution

Configuration **RGB**

2560x1440 (QHD)



Technical Specifications

Interface eDP 1.3 + PSR **LCD Mode** IPS/FFS/VA

Viewing Angle UWVA 85/85/85/85

35.56 cm (14") diagonal Outline Dimensions **LED backlight FHD Slim eDP SVA (1920 x 1080) Touch**

 $(W \times H \times D)$

Active Area 309.40 x 173.95 (mm)

Weight 270 g max

Diagonal Size 14"

Surface Treatment Anti-smudge/fingerprint coating

Touch Enabled Yes

TSP Type Capacitive **Contrast Ratio** 300:1 (typ) **Refresh Rate** 60 Hz Response time 16ms typ. Pixel Per Inch (PPI) 157 **Brightness** 300nits

Format 1920 x 1080 (FHD) **Pixel Resolution**

Configuration **RGB**

320.9 x 205.6 (mm) max x 3.0 (mm) max

Interface eDP 1.2 **LCD** Mode TN

Viewing Angle SVA 45/45/25/35

39.6 cm (15.6") diagonal Outline Dimensions **LED backlight HD Slim** eDP SVA Anti-glare nontouch

(1366 x 768)

 $(W \times H \times D)$

360.0 x 224.3 x 3.2 (mm) max

Active Area 344.2 x 193.5 (mm)

Weight 370g max **Diagonal Size** 39.6 cm (15.6") Surface Treatment Anti-Glare (AG) **Contrast Ratio** 300:1 (typ) **Refresh Rate** 60Hz Response time 16ms typ.

Pixel Per Inch (PPI) 101

Brightness 220 nit typ

Pixel Resolution Format 1366 x 768 (HD)



Configuration **RGB**

360.0 x 224.3 x 3.2 (mm) max

Interface eDP 1.2 **LCD Mode** TN

Viewing Angle SVA 45/45/25/35

39.6 cm (15.6") diagonal Outline Dimensions LED backlight FHD Slim eDP SVA Anti-glare nontouch

(1920 x 1080)

 $(W \times H \times D)$

Active Area 344.2 x 193.5 (mm)

Weight 360 g max. **Diagonal Size** 39.6 cm (15.6") **Surface Treatment** Anti-Glare (AG) **Contrast Ratio** 400:1 (typ) **Refresh Rate** 60Hz

Response time 16ms typ. Pixel Per Inch (PPI) 142 **Brightness** 300nits

Format 1920 x 1080 (FHD) **Pixel Resolution RGB**

Configuration eDP 1.2 Interface

LCD Mode TN

Viewing Angle SVA 45/45/25/35

39.6 cm (15.6") diagonal LED backlight **UHD Slim eDP UWVA** Anti-glare non-touch (3840 x 2160)

Dimensions (W x H x D) 368.48 x 218.81 x 3.14 (mm) max

Diagonal Size 15.6 in (39.6 cm) Weight 345 g (max) **Surface Treatment** Anti-glare (AG) **Contrast Ratio** 1000:1 (typ) **Refresh Rate** 60 Hz

Brightness 340 nit

Pixel Resolution

Format 3840x2160 (UHD)

Configuration **RGB**

Backlight **LED**



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC **HP EliteBook 850 G4 Notebook PC**

Technical Specifications

PPI 282

Viewing Angle 80° Horizontal. ±80° Vertical (minimum)

80/80/80/80 (Left/Right/Down/Up) (min) UWVA 85/85/85

39.6 cm (15.6") diagonal Outline Dimensions **LED backlight FHD Slim eDP SVA (1920 x 1080) Touch**

360.0 x 224.3 x 3.2 (mm) max

 $(W \times H \times D)$ **Active Area**

344.2 x 193.5 (mm)

Weight **Diagonal Size** 360 g max. 39.6 cm (15.6")

Surface Treatment

Anti-smudge/fingerprint coating

Contrast Ratio

400:1 (typical)

Touch Enabled

Yes

TSP Type **Refresh Rate** Response time Capacitive 60Hz

Pixel Per Inch (PPI) **Brightness**

16ms typ. 142

300nits

Pixel Resolution

Format

1920 x 1080 (FHD)

Configuration

RGB

Interface eDP 1.2 **LCD** Mode TN

Viewing Angle SVA 45/45/25/35

NETWORKING

HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module

Technology/Operating bands

LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8). 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower).

800 (Band 20), 700 (Band 28).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

EV-DO: 850 (BCO), 1900 (BC1) MHz (Only work with Verizon network) E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8)

MHz



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

Wireless protocol standards 3GPP Release 10 LTE Specification CAT.4, 20MHz BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

1xEVDO Release O, A and B.

E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

GPS Standalone, A-GPS (MS-A, MS-B and XTRA)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVDO Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVDO Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm 1xRTT/EVDO: 24dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average) 1xRTT/EVDO: 1,000 mA (peak); 700 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6.2 g

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

4G LTE not available on all products or in all countries.

HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating bands LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz,

850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz,

800 (Band 20), 700 (Band 28) MHz.

HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz

Wireless protocol standards 3GPP Release 10 LTE Specification CAT.4, 20MHz BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

GPS Standalone, A-GPS (MS-B and LTO)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps (Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,600 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 q

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

HP hs3210 WW HSP with GPS Mobile Broadband

HP hs3210 HSPA+ Mobile Broadband Module*

Technology/Operating bandsHSPA+: 2100 (Band1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz

Wireless protocol standards WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

Maximum data rates HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)

E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload)

Maximum output power HSPA+: 24 dBm

E-GPRS 1800/1900: 26 dBm

E-GPRS 850/900: 27 dBm GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm

Maximum power consumption HSPA+: 1,100 mA (peak); 800 mA (average)

E-GPRS: 2,800 mA (peak); 700 mA (average)

Form Factor M.2, 2242-S3 Key B



^{*} Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability.

Connection speeds will vary due to location, environment, network conditions, and other factors.

4G LTE not available on all products or in all countries.

Weight 6 g

Dimensions 1.65 x 8.66 x 0.09 in (42 x 22 x 2.38 mm)

(Length x Width x Thickness)

Note: Wireless access point and Interet service required. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices."

Intel® Dual Band Wireless-AC 8265 802.11 a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 combo

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

• 2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia no support this band)

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11q: 6, 9, 12, 18, 24, 36, 48, 54 Mbps



^{*} Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

AES-CCMP: 128 bit in hardware

mode only

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g

WPA2 certification

• IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX

Lite

WAPI

Network Architecture

Models

Security¹

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power²

• 802.11b: +16dBm minimum

802.11g: +14dBm minimum

802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum

802.11n HT20(5GHz): +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)



Technical Specifications

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps : -86dBm maximum

802.11g, 6Mbps: -88dBm maximum

802.11g, 54Mbps: -74dBm maximum

802.11a, 6Mbps: -88dBm maximum

802.11a, 54Mbps : -74dBm maximum

802.11n, MCS07: -69dBm maximum

802.11n, MCS15: -66dBm maximum

802.11ac, 1SS, MCS-0: -86dBm maximum

802.11ac, 1SS, MCS-9: -61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r



Type 1630: 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity Modulation 0.01% BER 0.001% BER



Technical Specifications

LegacyGFSK-80 dBm-70 dBm

π/4-DQPSK -80 dBm -70 dBm

8DPSK -80 dBm -70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Bluetooth Profiles Supported

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

Certifications UL, CSA, and CE Mark

Bluetooth Profiles Supported Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)^{1,2}

Generic Object Exchange Profile (GOEP)^{1,2}



Object Push Profile (OPP)1,2

Hard Copy Cable Replacement (HCRP)^{1,2} Personal Area Networking Profile (PAN)^{1,2} Human Interface Device Profile (HID)^{1,2}

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Audio Video Remote Control Profile (AVRCP)

Bluetooth V4.1/V4.2 support feature

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Intel® Dual Band Wireless-AC 3168 802.11 a/b/g/n/ac (1x1) WiFi and Bluetooth® 4.2 combo

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or



otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power²

- 802.11b: +16dBm minimum
- 802.11g: +14dBm minimum
- 802.11a: +14dBm minimum
- 802.11n HT20(2.4GHz): +14dBm minimum



Technical Specifications

• 802.11n HT40(2.4GHz): +12dBm minimum

• 802.11n HT20(5GHz): +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

802.11ac 80MHz(5GHz): +11dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum

802.11q, 6Mbps: -88dBm maximum

802.11g, 54Mbps : -74dBm maximum

802.11a, 6Mbps: -88dBm maximum

802.11a, 54Mbps: -74dBm maximum

802.11n, MCS07: -69dBm maximum

802.11n, MCS15: -66dBm maximum

802.11ac, 1SS, MCS-0: -86dBm maximum

802.11ac, 1SS, MCS-9: -61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure



Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1.Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy : 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps



BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity

Legacy

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Bluetooth Profiles Supported

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,2

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)1,2

Hard Copy Cable Replacement (HCRP)^{1,2}
Personal Area Networking Profile (PAN)^{1,2}

Human Interface Device Profile (HID)^{1,2}

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Audio Video Remote Control Profile (AVRCP)

Bluetooth V4.1/V4.2 support

feature

Certifications

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Intel® I219-V Gigabit Network Connection

Ethernet 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3

Features clauses 13-14)

100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE

802.3 clauses 13-14)



100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE

802.3 clauses 21-30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE

8023. Clauses 40)

Auto-Negotiation (Automatic Speed Selection)
Full Duplex Operation at all Speeds, Half Duplex

operation at 10 and 100 Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32;

configurable)

IEEE 802.3az EEE(Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection

PowerACPI compliant - multiple power modesManagementEnergy Detect Low Power Mode(Green Ethernet)

Performance TCP/IP/UDP Checksum Offload (configurable)

Features Protocol Offload(ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling MACSec Offload (802.3ae)

Intel Non-vPro iSCSI Boot

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ.

NOTE: Intel 82579 PCIe interface is not PCIe compliant. It operates at half

of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name Intel 82579LM/82579V Ethernet Network Connection

Intel® I219-LM Gigabit Network Connection



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023. Clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE(Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection

Power ACPI compliant - multiple power modes

Management Energy Detect Low Power Mode(Green Ethernet)

Performance TCP/IP/UDP Checksum Offload (configurable)

Features Protocol Offload(ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling MACSec Offload (802.3ae)

Intel vPro iSCSI Boot

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ.

NOTE: Intel 82579 PCIe interface is not PCIe compliant. It operates at half

of PCIe specification V1.1 (2.5GT/S) speed.

NIC Device Driver Name Intel 82579LM/82579V Ethernet Network Connection

Near Field Communications Controller (optional)

Dimensions (L x W x H) Module 25 mm by 10 mm by 2.0 mm



Chipset NPC100

System interface I²C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode(1) ISO/IEC 14443 A

ISO/IEC 14443 B
ISO/IEC 15693
MIFARE 1K
MIFARE 4K
MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-VICC) Mode(1) ISO/IEC 14443 A

ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer

Raw RF Data Rates 106, 212, 424, 848 kbps

Operating temperature 0°C to 70°C

Storage temperature -20°C to 125°C



Humidity 10-90% operating

5-95% non-operating

Supply Operating voltage 2.97 to 5.5 Volts

I/O Voltage 1.8V or 3.3V

Power Consumption Mode Power Consumption,

(Booster enable, VBAT= 3.3V, VCC_BOOST =

(booster enable, VDA I = 3.3V, VCC_boost =

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna

matching is external to module.

STORAGE AND DRIVES

500 GB 7200rpm Self Encrypting Drive (FIPS-140-2) (Opal 2)

 Drive Weight
 0.21 lbs (95 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s



Technical Specifications

Seek TimeSingle Track1.5 ms(typical reads, including
settling)Average12 msMaximum21 ms

Cache32 MBRotational Speed7200 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Features ATA Security; TCG Opal 2.x, FIPS, S.M.A.R.T., NCQ, Ultra DMA—,

500 GB 7200rpm Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.21 lbs (95 g)

Capacity 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek TimeSingle Track1.5 ms ~ 2 ms(typical reads, including settling)Average11 ms ~ 13 msMaximum18 ms ~ 22 ms

Cache32 MBRotational Speed7200 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200rpm Self- Drive We Encrypting Drive (Opal 2) Capacity

 Drive Weight
 0.21 lbs (95 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek TimeSingle Track1.5ms(typical reads, including settling)Average12msMaximum21 ms

Cache 32 MB
Rotational Speed 7200rpm
Logical Blocks 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]



Features ATA Security; TCG Opal 2.x, S.M.A.R.T., NCQ, Ultra DMA

18ms-22ms

1 TB 5400rpm Hard Drive **Drive Weight** 0.21 lbs (94 g)- 0.21 lbs (95 g)

Capacity 1TB

settling)

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek TimeSingle Track2ms(typical reads, includingAverage12ms-13ms

Maximum

Cache Up to 32-MB
Rotational Speed 5400rpm
Logical Blocks 1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

500 GB Hybrid, 8 GB cache **Drive Weight** 0.20 lbs (92 g) ~ 0.21 lbs (95 g)

 Capacity
 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer RateSynchronous (maximum)600 MB/sSeek TimeSingle Track2 ms(typical reads, including settling)Average12 msMaximum22 ms

Cache64 MBRotational Speed5400 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security, S.M.A.R.T., NCQ, Ultra DMA

128 GB SATA-3 Value Solid State Drive **Drive Weight** 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 128 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0



Performance Maximum Sequential Read Maximum Sequential Write

Up To 535 MB/s Up To 515 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB PCIe Gen3x4 NVMe TLC Solid State Drive **Drive Weight** M.2 2280 **Capacity** 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

512 GB PCIe Gen3x4 NVMe TLC Solid State Drive **Drive Weight** M.2 2280 **Capacity** 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

512 GB PCIe Gen3x4 NVMe MLC Solid State Drive **Drive Weight** M.2 2280 **Capacity** 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write



Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

256 GB SATA-3 TLC Self-Encrypting Solid State Drive (Opal 2)

Drive Weight M.2 2280 Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

Up to 530 MB/s Up to 515 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TCG Opal 2.0; DIPM; TRIM; DEVSLP

512 GB PCIe Gen3x4 NVMe TLC Self-Encrypting Solid State Drive (Opal 2) **Drive Weight** M.2 2280 **Capacity** 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Logical Blocks 1,000,215,216

Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesATA Security (Option); TCG Opal 2.0; TRIM; L1.2



POWER

HP 45W Smart AC Adapter

Dimensions $(H \times W \times D)$

Weight

Input

9.5 x 4.0 x 2.65 cm) unit: 200g +/- 10g 90 to 265 VAC

> **Input Efficiency** 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 to 63 Hz

Input AC current Max. 1.4 A at 90 Vac

45W Output **Output power DC** output 19.5V

> Hold-up time 5 ms at 115 Vac input

Output current limit <8.0A

AC Connector (Ac Inlet) Environmental Design

C6 (3pin/with grounded, with Smart ID DC connector) Operating 32° to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 45W Smart AC Adapter (2 Prong) **Dimensions** $(H \times W \times D)$

Weight

Input

95.0x40.0x26.5mm unit: 200g +/- 10g 90 to 265 VAC

87.74% at 115Vac and 88.4% at 230Vac **Input Efficiency**

47 to 63 Hz Input frequency range

Max. 1.4 A at 90 Vac Input AC current

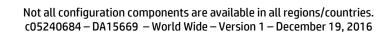
45W Output **Output power**

DC output 19.5V

Hold-up time 5 ms at 115Vac input

Output current limit <8.0A

AC Connector (Ac Inlet) C8 (2 pin/non-grounded, with Smart ID DC connector) **Environmental Design** Operating 32° to 95° F (0° to 35° C)





temperature

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety *CE Mark - full compliance with LVD and EMC directives

Certifications * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC Adapter

Dimensions 107.0x47.0x30.0mm Weight unit: 250g +/- 10g Input 90 to 265 VAC

> **Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 to 63 Hz **Input AC current** 1.7 A at 90 Vac

Output **Output power** 65W

> DC output 19.5V

Hold-up time 5 ms at 115 Vac input

Output current limit <11.0A

AC Connector (Ac Inlet)

C6 (3pin/with grounded, with Smart ID DC connector) **Environmental Design** Operating

temperature

32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety

*CE Mark - full compliance with LVD and EMC directives **Certifications**

> * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B. CISPR22 Class B. CCC. NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Technical Specifications

HP 65W Smart AC Adapter EM
 Dimensions
 102.0x55.0x30.0mm

 Weight
 unit: 350g +/- 10g

 Input
 90 to 265 VAC

Input Efficiency 87.0% min at 115 VAC and 230Vac

Input frequency range 47 to 63 Hz
Input AC current 1.7 A at 90 VAC

Output Output power 65W

DC output 19.5V

Hold-up time 5 ms at 115 Vac input

Output current limit <11.0A

AC Connector (Ac Inlet) C6 (3pin/with grounded, with Smart ID DC connector)

Environmental Design Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 3-cell Long Life Li-Ion (49 WHr) – HP EliteBook 820 G4 **Dimensions** (H x W x L) 8.

8.30 mm x127.5 mm x 160.25 mm

Weight 225g

Cells/Type 3 cell Lithium-Ion Polymer cell / 505295
Energy Voltage 11.55V

Amp-hour capacity 4250mAh
Watt-hour capacity 49Wh

Temperature Operating (Charging) 0~45 C **Operating (Discharging)** -10~60 C

Fuel Gauge LED NA

Warranty 1000 cycles > 65% (at 23°C)

Optional Travel Battery

Available

No

HP 3-cell Long Life Li-Ion (51 WHr) – HP **Dimensions** $(H \times W \times L)$

6.8mm x 102.8mm x 198mm

Weight 235g



EliteBook 840 & 850 G4 Cells/Type 3cell Lithium-Ion Polymer cell / 506480

Energy Voltage 11.55V

Amp-hour capacity 4420mAh Watt-hour capacity 51wh

Temperature Operating (Charging) 0~45~C

Operating (Discharging) -10~60 C

Fuel Gauge LED NA

Warranty 1000 cycles > 65% (at 23°C)

Optional Travel Battery N

Available

ENVIRONMENTAL

HP EliteBook 820 G4 Notebook PC

Eco-Label Certifications & declarations System Configuration	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: • IT ECO declaration • US ENERGY STAR® • EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in your country. The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".				
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz 230VAC, 50Hz 100VAC, 50Hz				
Normal Operation (Short idle)	5.15 W	5.15 W	4.66 W		
Normal Operation (Long idle)	2.80 W 3.23 W 2.80 W				
Sleep	0.74 W	0.83 W	0.77 W		



Off	0.40 W	0.48 W	0.40 W		
	family. HP computers ma Environmental Protection does not offer ENERGY S	arked with the ENERGY STA Agency (EPA) ENERGY STAR STAR® compliant configurat eaturing a hard disk drive,	© compliant product if offered within the model AR® Logo are compliant with the applicable U.S. R® specifications for computers. If a model family ions, then energy efficiency data listed is for a a high efficiency power supply, and a Microsoft		
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short idle)	18 BTU/hr	18 BTU/hr	16 BTU/hr		
Normal Operation (Long idle)	10 BTU/hr	11 BTU/hr	10 BTU/hr		
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr		
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr		
	*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service attained for one hour.				
Declared Noise	Sound Power		Sound Pressure		
Emissions	(L _{WAd} , bels)		(L _{pAm} , decibels)		
(in accordance with ISO 7779 and ISO 9296)					
Typically Configured — Idle	3.2		26		
Fixed Disk – Random writes	3.5		27		
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC				



Additional Information	Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight Battery size: CR2320 (coin cell) Battery type: Lithium This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the gold level, see www.epeat.net					
	PlasISO1This	tics parts weighing over 25 grams used in the product are 043. product contains 0% post-consumer recycled plastic (by product is 96.7% recycle-able when properly disposed of	wt.)			
Packaging Materials	External:	PAPER/Corrugated	328 g			
	Internal:	PLASTIC/Expanded Polyethylene - EPE	38 g			
		PLASTIC/Polyethylene low density - LDPE	14 g			
		PLASTIC/Polypropylene - PP	3 g			
	The plastic p	backaging material contains at least 50% recycled content	•			
		ted paper packaging materials contains at least 70% recy				
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):					
	 Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) 					



	 Polybrominated Biphenyl Oxides (PBBOs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/qo/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/qo/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP 0EM customers who integrate and re-sell HP equipment.
HP Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Technical Specifications

HP EliteBook 840 G4 Notebook PC

Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may be				
& declarations	labeled with one or more of these marks:				
System Configuration	 IT ECO declaration US ENERGY STAR® EPEAT <gold> registered in the United States. See http://www.epeat.net for registration status in your country.</gold> The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook". 				
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short idle)	5.12 W	5.47 W	5.18 W		
Normal Operation (Long idle)	3.00 W	3.26 W	3.50 W		
Sleep	0.66 W	0.66 W	0.67 W		
Off	0.40 W	0.40 W	0.40 W		
	Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.				
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

QuickSpecs

Normal Operation (Short idle)	18 BTU/hr 19 BTU/hr		U/hr	18 BTU/hr
Normal Operation (Long idle)	10 BTU/hr	11 BTU/hr		12 BTU/hr
Sleep	2 BTU/hr	2 BT	J/hr	2 BTU/hr
Off	1 BTU/hr	1 BTU/hr		1 BTU/hr
	*NOTE: Heat dissipation attained for one hour.	is calculated l	pased on the	measured watts, assuming the service level is
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)			Sound Pressure (L _{pAm} , decibels)
Typically Configured — Idle	2.9		21	
Fixed Disk – Random writes	3.2			22
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight Battery size: CR2032 (coin cell) Battery type: Lithium			



Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net</gold> Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. This product contains 0% post-consumer recycled plastic (by wt.) This product is 94.6% recycle-able when properly disposed of at end of life. 					
Packaging Materials	External:	PAPER/Corrugated	323 g			
	Internal:	PLASTIC/Polyethylene Expanded - EPE	38 g			
		PLASTIC/Polyethylene low density - LDPE	15 g			
		PLASTIC/Polypropylene - PP	4 g			
Material Usage	The plastic packaging material contains at least 50% recycled content. The corrugated paper packaging material contains at least 70% recycled content. This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf): - Asbestos - Certain Azo Colorants - Certain Brominated Flame Retardants – may not be used as flame retardants in plastics - Cadmium - Chlorinated Hydrocarbons - Chlorinated Paraffins - Formaldehyde - Halogenated Diphenyl Methanes - Lead carbonates and sulfates - Lead and Lead compounds - Mercuric Oxide Batteries - Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user Ozone Depleting Substances - Polybrominated Biphenyls (PBBs) - Polybrominated Biphenyl Ethers (PBBEs) - Polybrominated Biphenyl Oxides (PBBOs) - Polychlorinated Biphenyl (PCB) - Polychlorinated Terphenyls (PCT) - Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.					



Technical Specifications

Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.
and Recycling	To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP 0EM customers who integrate and re-sell HP equipment.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate Environmental Information	Global Citizenship Report http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and
	http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/cert.pdf

HP EliteBook 850 G4 Notebook PC



Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may be				
& declarations	labeled with one or more of these marks:				
System Configuration	 IT ECO declaration US ENERGY STAR® EPEAT <gold> registered in the United States. See http://www.epeat.net for registration status in your country.</gold> The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook". 				
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz 230VAC, 50Hz 100VAC, 50Hz				
Normal Operation (Short idle)	5.86 W	5.86 W	5.99 W		
Normal Operation (Long idle)	3.14 W	3.73 W	3.40 W		
Sleep	0.71 W	0.79 W	0.72 W		
Off	0.40 W 0.48 W 0.40 W		0.40 W		
	Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.				
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short idle)	20 BTU/hr	20 BTU/hr	20 BTU/hr		
Normal Operation (Long	11 BTU/hr	13 BTU/hr	12 BTU/hr		



idle)						
Sleep	2 BTI	J/hr	3 BTU/hr			2 BTU/hr
Off	1 BTI	J/hr	2 BTU/	'hr		1 BTU/hr
		Heat dissipation is calculated based on the measured watts, assuming the service d for one hour.				s, assuming the service level is
Declared Noise		Sound Power			Sound	d Pressure
Emissions		(L _{WAd} , bels)			(L _{pAm} ,	decibels)
(in accordance with ISO 7779 and ISO 9296)						
Typically Configured – Idle		2.9		22		22
Fixed Disk – Random writes	3.5			28		
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight Battery size: CR2032 (coin cell)					
	Battery type:					
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net</gold> Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. This product contains 0% post-consumer recycled plastic (by wt.) This product is 95.2% recycle-able when properly disposed of at end of life. 					
Packaging Materials	External:	PAPER/Corr	rugated			348 g
				anded FDF		
	miternat:	Internal: PLASTIC/Polyethylene Expanded - EPE				38 g



	PLASTIC/Polyethylene low density - LDPE	15 g			
	PLASTIC/Polypropylene - PP 5 g				
	The plastic packaging material contains at least 50% recycled con	itent.			
	The corrugated paper packaging materials contains at least 70% i	recycled content.			
Material Usage	This product does not contain any of the following substances in e	xcess of regulatory limits (refer to the			
material Usage	Inis product does not contain any of the following substances in e HP General Specification for http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qs - Asbestos - Certain Azo Colorants - Certain Brominated Flame Retardants – may not be used a - Cadmium - Chlorinated Hydrocarbons - Chlorinated Paraffins - Formaldehyde - Halogenated Diphenyl Methanes - Lead carbonates and sulfates - Lead and Lead compounds - Mercuric Oxide Batteries - Nickel – finishes must not be used on the external surface carried by the user Ozone Depleting Substances - Polybrominated Biphenyls (PBBs) - Polybrominated Biphenyl Ethers (PBBEs) - Polybrominated Biphenyl Oxides (PBBOs) - Polychlorinated Biphenyl (PCB) - Polychlorinated Terphenyls (PCT) - Polyvinyl Chloride (PVC) – except for wires and cables, and voluntarily removed from most applications Radioactive Substances - Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (**)	the Environment at se.pdf): as flame retardants in plastics designed to be frequently handled or			
Packaging Usage	HP follows these guidelines to decrease the environmental impact Eliminate the use of heavy metals such as lead, chromium materials. Eliminate the use of ozone-depleting substances (ODS) in Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content mat Use readily recyclable packaging materials such as paper and the second materials are marked according to ISO 1	n, mercury and cadmium in packaging packaging materials. erials in packaging materials. and corrugated materials. ation fuel efficiency.			



End-of-life Management	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.					
and Recycling	To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP					
	sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.					
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/qo/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.					
Hewlett-Packard	For more information about HP's commitment to the environment:					
Corporate						
Environmental	Global Citizenship Report					
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html					
	Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html					
	ISO 14001 certificates:					
	150 1 100 1 certificates.					
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842					
	and					
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf					

COUNTRY OF ORIGIN

China



Options and Accessories (Sold separately and availability may vary by country.)

Туре	Description	Part Number
Docking	HP USB-C Travel Dock	T0K29AA#xxx
	HP USB Travel Dock	T0K30AA#xxx
	HP UltraSlim Docking Station	D9Y32AA#xxx
	HP Elite USB-C Docking Station	X7W54AA
	HP Adjustable Dual Display Stand	AW664AA
	HP Display and Notebook Stand II	E8G00AA
Input/Output	HP Slim Wireless Keyboard and Mouse	T6L04AAxxx
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Conferencing Keyboard	K8P74AA
	HP Ultrathin Wireless Mouse	L9V78AA
	HP UC Speaker Phone	K7V16AA
	HP UC Wired Headset	K7V17AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP UC Wireless Mono Headset	W3K08AA
	HP UC Wireless Duo Headset	W3K09AA
	HP USB Speaker Phone	X7N17AA
Memory	HP 4GB 2133MHz DDR4 Memory	T7B76AA
	HP 8GB 2133MHz DDR4 Memory	T7B77AA
Power	HP 65W Slim AC Adapter	H6Y82AA#xxx
	HP 90W Slim AC Adapter	H6Y83AA#xxx
	HP 90W Slim Combo AC Adapter w/ USB	H6Y84AA#xxx
	HP 45W Smart AC Adapter	H6Y88AA#xxx
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP 90W Smart AC Adapter	H6Y90AA#xxx
	HP Notebook Power Bank	N9F71AA#xxx
Storage	HP USB External DVDRW Drive	F2B56AA
Security	HP Combination Lock	TOY15AA
	HP Keyed Cable lock	TOY14AA
Displays	HP EliteDisplay E232 23-inch Monitor	M1N98AA
	HP EliteDisplay S231d 23-inch Notebook Docking Monitor	F3J72AA
	HP Elite Display S140u 14-inch USB Portable Monitor	G8R65AA



HP EliteBook 820 G4 Notebook PC HP EliteBook 840 G4 Notebook PC HP EliteBook 850 G4 Notebook PC

Change Log

Date of change	Version History		Description of change	
December 19, 2016	V1	Launch	Quickspecs launched	

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